

## FEATURES

- Constant LED Current for Varying Input Voltage
- Adjusted Current Operation
- Low Quiescent Current
- Simplifies Circuit and System Designs
- Compact Component Count
- Provided Higher Current by Parallel
- Temperature Compensated Constant Current
- Over Current Protection
- Over Temperature Protection
- LED Current Programmable Thermal Foldback for thermal Protection
- SOP-8L Package or DFN-8L Package or TO252-5L Package

## APPLICATIONS

- LED Driver
- Lighting Applications
- Lamp Indicators
- Candle Light
- Low Cost solution
- Constant Current Source

## TYPICAL APPLICATION CIRCUIT

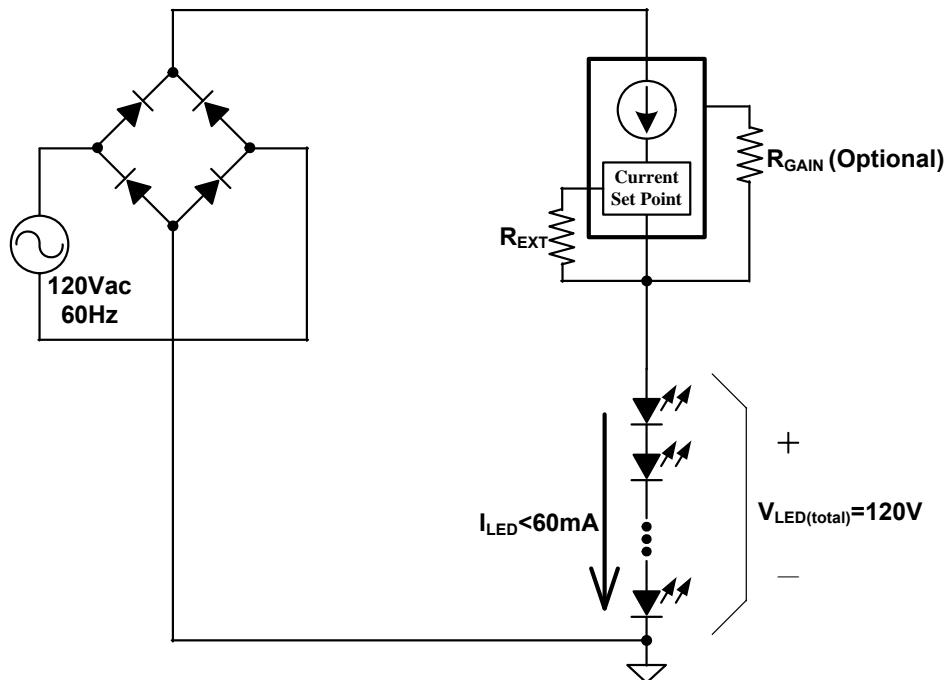


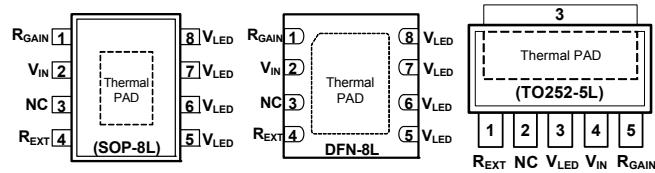
Fig. 1 Simplified Application Circuit



## ABSOLUTE MAXIMUM RATINGS

V <sub>IN</sub> Supply Voltage.....	500V
R <sub>EXT</sub> , R <sub>GAIN</sub> Operation Voltages.....	6V
Operating Temperature.....	-40°C to +125°C
Storage Temperature.....	-55°C to +150°C
Maximum Die Temperature.....	+150°C
Lead Temperature.....	+260°C
ESD HBM Voltage.....	2.5kV
ESD MM Voltage.....	300V

## PIN CONFIGURATION

**Note:**

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability.

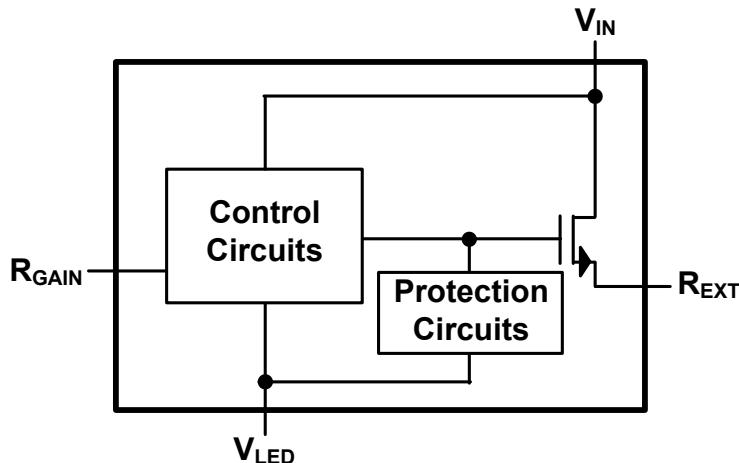
## Ordering Information

Part No.	Package Type	Marking Information	Remark
EC4211NNMHR	SOP-8L	EC4211 YYWW LLLLLT	YYWW : Date Code LLLLL : Lot No T : internal tracking code
EC4211NNF2R	DFN-8L	EC4211 LLLLL YYWWT	
EC4211NNA5R	TO252-5L	EC4211 YYWW LLLLLT	

## ELECTRICAL CHARACTERISTICS

T<sub>A</sub> = 25°C unless otherwise specified

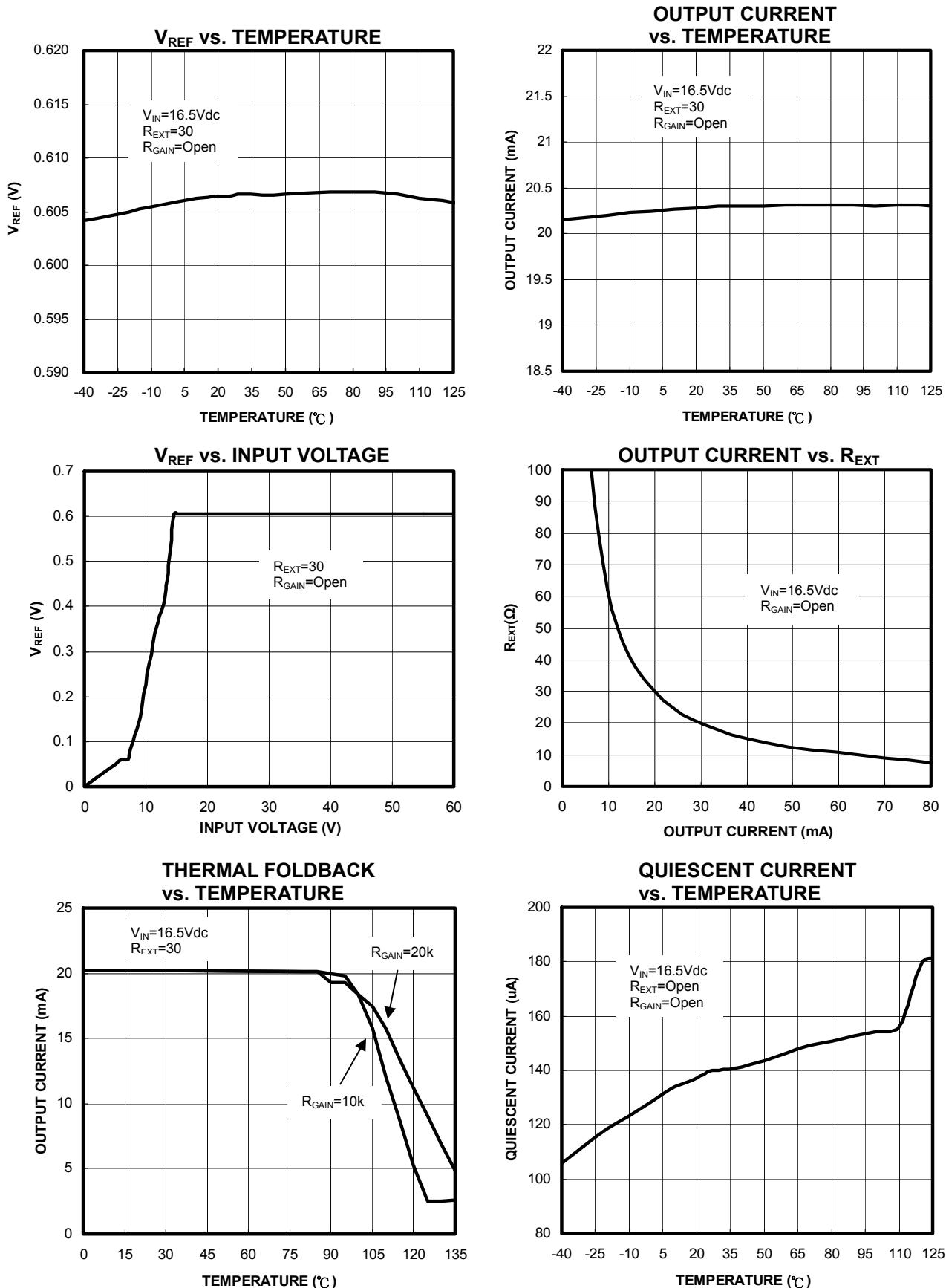
PARAMETER		CONDITIONS	MIN	TYP	MAX	UNIT
<b>Electrical Characteristic</b>						
V <sub>IN</sub>	Operation Voltage		15		265	V
I <sub>LED</sub>	Current Regulation (Note 1)	V <sub>IN</sub> =120Vdc, R <sub>EXT</sub> =15Ω, V <sub>LED</sub> =100V	38.16	40.17	42.18	mA
		V <sub>IN</sub> =220Vdc, R <sub>EXT</sub> =30Ω, V <sub>LED</sub> =200V	19.16	20.17	21.18	mA
I <sub>LED(MAX)</sub>	Maximum Current Regulation	V <sub>DROP</sub> ≤16V (Note 2)			60	mA
I <sub>Q</sub>	Quiescent Current	V <sub>IN</sub> =20Vdc, R <sub>EXT</sub> =Open		170		μA
V <sub>REF</sub>	Reference Voltage (Note 3)			0.6		V
V <sub>DROP(MAX)</sub>	Maximum Dropout Voltage (Note 4)	V <sub>IN</sub> = 265Vac, R <sub>EXT</sub> =30Ω, V <sub>LED</sub> =220V			170	V
<b>Thermal Characteristic</b>						
△V <sub>REF(T)</sub>	V <sub>REF</sub> Temperature Coefficient	T <sub>A</sub> =-40°C ~125°C		0.01		%/°C
T <sub>A</sub>	Operating Temperature		-40		125	°C
P <sub>D</sub>	Total Power Dissipation (Operation)				1	W
R <sub>θJA</sub>	Thermal Resistance	SOP-8L Package		75		°C/W
		DFN-8L Package		33.2		°C/W
		TO252-5L Package		68		°C/W
<b>Protection</b>						
OCP	Over Current Protection			150		mA
OTP	Over Temperature Protection			150		°C
TFP	Thermal Foldback Protection (Note 5)			90		°C
<b>Note:</b>						
1. I <sub>LED</sub> =0.6/R <sub>EXT</sub> +I <sub>Q</sub>						
2. V <sub>DROP</sub> =V <sub>IN</sub> -V <sub>LED</sub> -0.6, P <sub>D</sub> <1W (No heat sink)						
3. V <sub>REF</sub> =V(R <sub>EXT</sub> )-V <sub>LED</sub>						
4. The current regulation is for a instantaneous AC line input current only, not to exceed thermal characteristics of package.						
5. I <sub>LED(TFP)</sub> =I <sub>LED</sub> -V(R <sub>GAIN</sub> )/R <sub>GAIN</sub>						

**FUNCTION DIAGRAM**

**Fig. 2 Detailed Block Diagram**
**PIN DESCRIPTIONS**
**TO252-5L Package**

PIN	Symbol	Description
1	R <sub>EXT</sub>	An external resistor between R <sub>EXT</sub> and V <sub>LED</sub> pin sets different current regulation for LED strings.
2	NC	No internal mechanically connection. Leave this pin open.
3	V <sub>LED</sub>	The LED strings are connected from this pin to ground.
4	V <sub>IN</sub>	Input supply voltage.
5	R <sub>GAIN</sub>	Programmable thermal foldback protection for current regulation to limit die temperature during high power operation or high ambient temperature conditions.

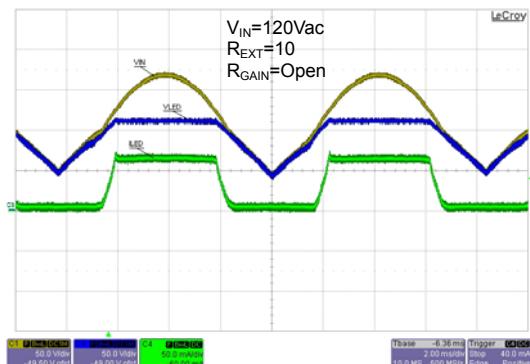
**DFN-8L / SOP-8L Package**

PIN	Symbol	Description
1	R <sub>GAIN</sub>	Programmable thermal foldback protection for current regulation to limit die temperature during high power operation or high ambient temperature conditions.
2	V <sub>IN</sub>	Input supply voltage.
3	NC	No internal mechanically connection. Leave this pin open.
4	R <sub>EXT</sub>	An external resistor between R <sub>EXT</sub> and V <sub>LED</sub> pin sets different current regulation for LED strings.
5, 6, 7, 8	V <sub>LED</sub>	The LED strings are connected from these pins to ground.

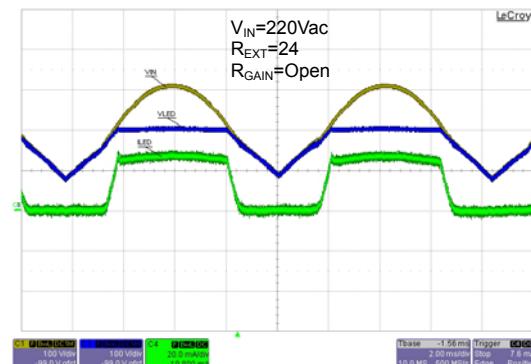
**ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , unless otherwise specified)**


## ELECTRICAL CHARACTERISTICS (Continued)

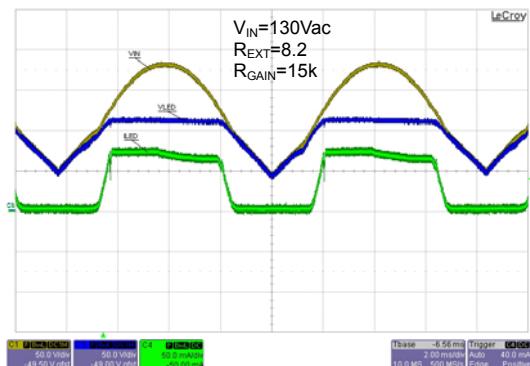
### TRANSIENT RESPONSE



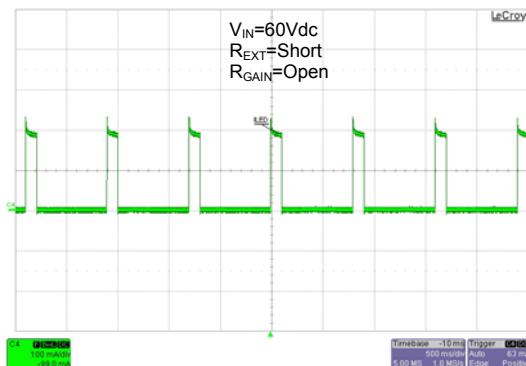
### TRANSIENT RESPONSE



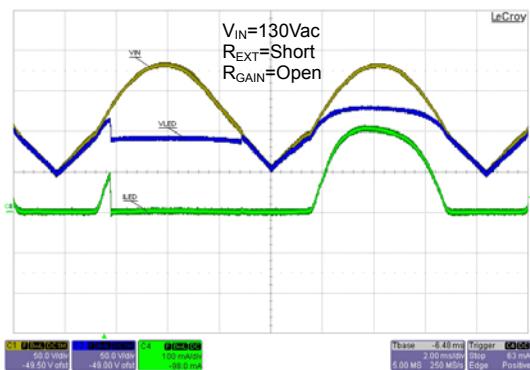
### TRANSIENT RESPONSE vs. THERMAL FOLDBACK

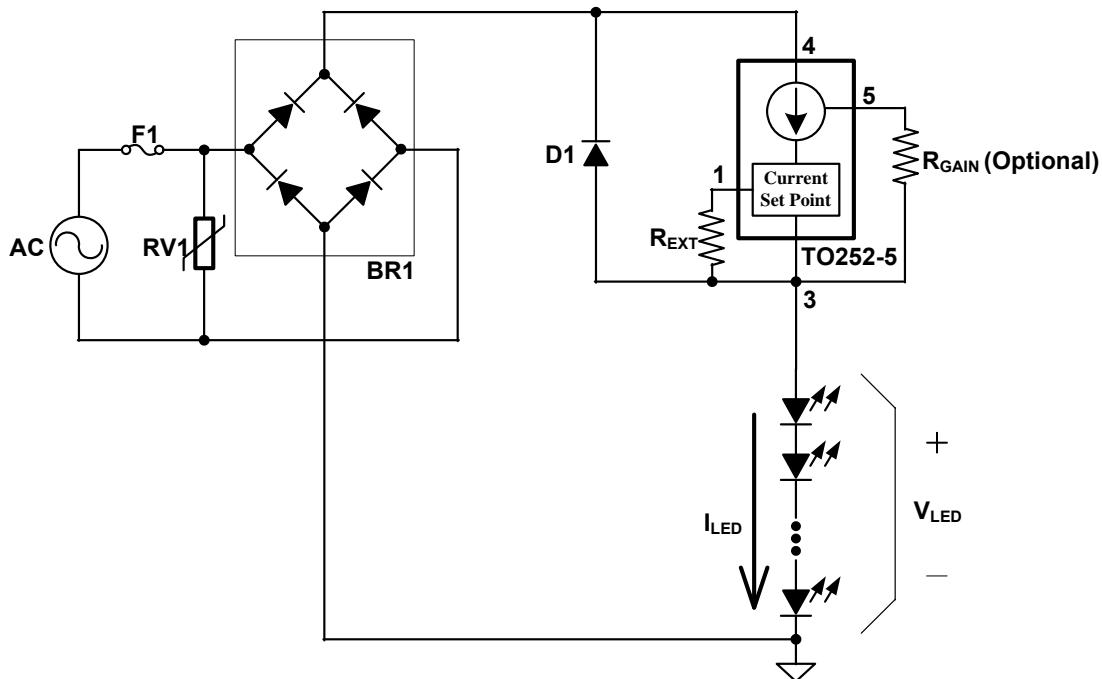


### OVER CURRENT PROTECTION



### OVER TEMPERATURE PROTECTION



**LED Lighting EC4211 Application Circuit Schematic**

**Fig. 3 Typical Application Circuit**
**110VAC 4W LED Lighting Demo Board Part List**

COMPONENT	VALUE	PACKAGE
U1	EC4211	TO252-5L
BR1	B10S	SMD
F1	1A	DIP
RV1	221KD14 (140VAC)	DIP
D1	1N4003	DIP
R <sub>EXT</sub>	8.5	0603
R <sub>GAIN</sub>	7.5k	0603
V <sub>LED</sub>	120V	NA

**220VAC 4W LED Lighting Demo Board Part List**

COMPONENT	VALUE	PACKAGE
U1	EC4211	TO252-5L
BR1	B10S	SMD
F1	1A	DIP
RV1	431KD14 (275VAC)	DIP
D1	1N4003	DIP
R <sub>EXT</sub>	24	0603
R <sub>GAIN</sub>	7.5k	0603
V <sub>LED</sub>	240V	NA

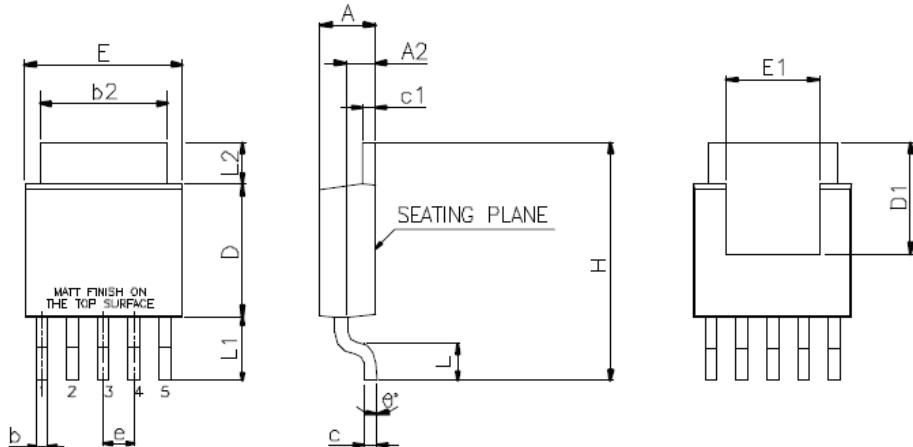
**Note:**

1. RV1 is for Surge Protection.
2. D1 is for Hi-POT protection.

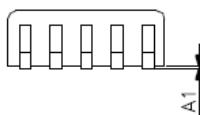


## OUTLINE DIMENSIONS (Dimensions shown in millimeters)

## TO252-5L Package

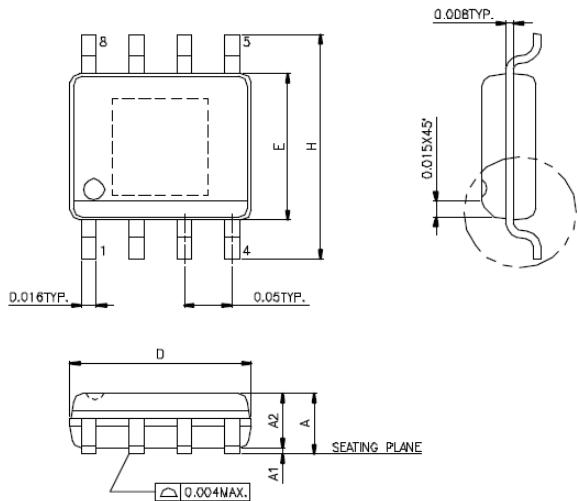


SYMBOLS	DIMENSIONS IN MILLIMETER	
	MIN.	MAX.
A	2.18	2.39
A1	0.00	0.13
A2	1.02	1.27
b	0.51 TYP.	
b2	5.21	5.46
c	0.46	0.58
c1	0.46	0.58
D	5.33	5.59
D1	4.57	—
E	6.35	6.73
E1	3.81	—
e	1.27 BSC.	
H	9.40	10.41
L	1.40	1.78
L1	2.67 REF.	
L2	1.52	2.03
$\theta^{\circ}$	0°	4°



NOTES:  
1. JEDEC OUTLINE : N/A

## SOP-8L Package



SYMBOLS	MIN.	MAX.
A	1.35	1.75
A1	0.05	0.15
A2	—	1.5
D	4.8	4.98
E	3.8	4.0
H	5.8	6.2
L	0.4	1.27
$\theta^{\circ}$	0	8

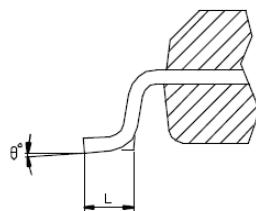
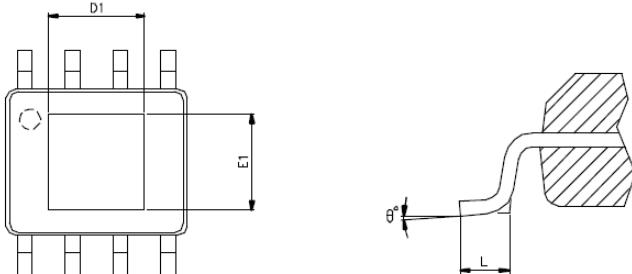
UNIT:mm

## THERMALLY ENHANCED DIMENSIONS

E1	D1
2.2 REF	3.0 REF

UNIT:mm

NOTES:  
1.JEDEC OUTLINE : N/A  
2.DIMENSIONS "D" DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED .15mm (.006in) PER SIDE.  
3.DIMENSIONS "E" DOES NOT INCLUDE INTER-LEAD FLASH, OR PROTRUSIONS. INTER-LEAD FLASH AND PROTRUSIONS SHALL NOT EXCEED .25mm (.010in) PER SIDE.





## DFN-8L Package

